TIBPAL16L8-10C, TIBPAL16R4-10C, TIBPAL16R6-10C, TIBPAL16R8-10C TIBPAL16L8-12M, TIBPAL16R4-12M, TIBPAL16R6-12M, TIBPAL16R8-12M HIGH-PERFORMANCE IMPACT-X ™ PAL® CIRCUITS

SRPS017A - D3023, MAY 1987 - REVISED DECEMBER 2010

High-Performance Operation:

f_{max} (w/o feedback)

TIBPAL16R'-10C Series . . . 62.5 MHz Min TIBPAL16R'-12M Series . . . 56 MHz Min

f_{max} (with feedback)

TIBPAL16R'-10C Series . . . 55.5 MHz Min

TIBPAL16R'-12M Series . . . 48 MHz Min

Propagation Delay

TIBPAL16L'-10C Series . . . 10 ns Max TIBPAL16L'-12M Series . . . 12 ns Max

- Functionally Equivalent, but Faster than, **Existing 20-Pin PLDs**
- **Preload Capability on Output Registers Simplifies Testing**
- Power-Up Clear on Registered Devices (All Register Outputs are Set Low, but Voltage Levels at the Output Pins Go High)
- Package Options Include Both Plastic and **Ceramic Chip Carriers in Addition to Plastic** and Ceramic DIPs
- **Security Fuse Prevents Duplication**

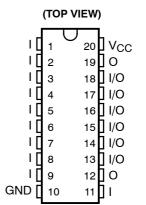
description

testing of all parameters.

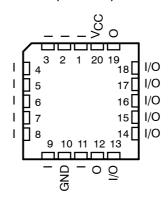
Dependable Texas Instruments Quality and Reliability

DEVICE	I INPUTS	3-STATE O OUTPUTS	REGISTERED Q OUTPUTS	I/O PORT S
PAL16L8	10	2	0	6
PAL16R4	8	0	4 (3-state buffers)	4
PAL16R6	8	0	6 (3-state buffers)	2
PAL16R8	8	0	8 (3-state buffers)	0

TIBPAL16L8 C SUFFIX . . . J OR N PACKAGE M SUFFIX . . . J PACKAGE



TIBPAL16L8' C SUFFIX . . . FN PACKAGE M SUFFIX . . . FK PACKAGE (TOP VIEW)



Pin assignments in operating mode

These programmable array logic devices feature high speed and functional equivalency when compared with currently available devices. These IMPACT-X™ circuits combine the latest Advanced Low-Power Schottky technology with proven titanium-tungsten fuses to provide reliable, high-performance substitutes for conventional TTL logic. Their easy programmability allows for quick design of custom functions and typically results in a more compact circuit board. In addition, chip carriers are available for futher reduction in board space.

All of the register outputs are set to a low level during power up. Extra circuitry has been provided to allow loading of each register asynchronously to either a high or low state. This feature simplifies testing because the registers can be set to an initial state prior to executing the test sequence.

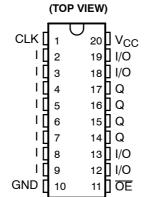
The TIBPAL16' C series is characterized from 0°C to 75°C. The TIBPAL16' M series is characterized for operation over the full military temperature range of -55°C to 125°C.

IMPACT-X is a trademark of Texas Instruments Incorporated. PAL is a registered trademark of Advanced Micro Devices Inc.

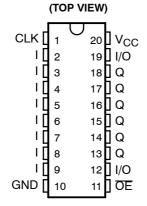
TIBPAL16R4-10C, TIBPAL16R6-10C, TIBPAL16R8-10C TIBPAL16R4-12M, TIBPAL16R6-12M, TIBPAL16R8-12M HIGH-PERFORMANCE $IMPACT-X \text{ }^{TM} PAL^{\textcircled{\tiny B}}$ CIRCUITS

<u>SRPS017A - D3023, MAY 1987 - REVI</u>SED DECEMBER 2010

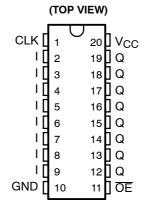
TIBPAL16R4' C SUFFIX . . . J OR N PACKAGE M SUFFIX . . . J PACKAGE



TIBPAL16R6'
C SUFFIX . . . J OR N PACKAGE
M SUFFIX . . . J PACKAGE

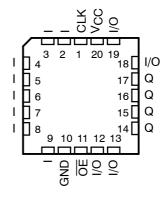


TIBPAL16R8'
C SUFFIX ... J OR N PACKAGE
M SUFFIX ... J PACKAGE

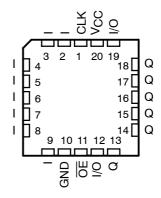


Pin assignments in operating mode

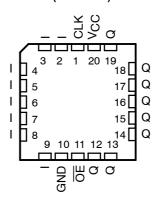
TIBPAL16R4'
C SUFFIX . . . FN PACKAGE
M SUFFIX . . . FK PACKAGE
(TOP VIEW)



TIBPAL16R6'
C SUFFIX . . . FN PACKAGE
M SUFFIX . . . FK PACKAGE
(TOP VIEW)

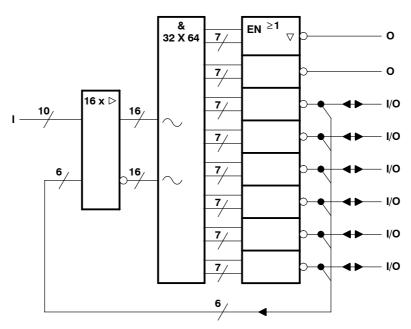


TIBPAL16R8'
C SUFFIX . . . FN PACKAGE
M SUFFIX . . . FK PACKAGE
(TOP VIEW)

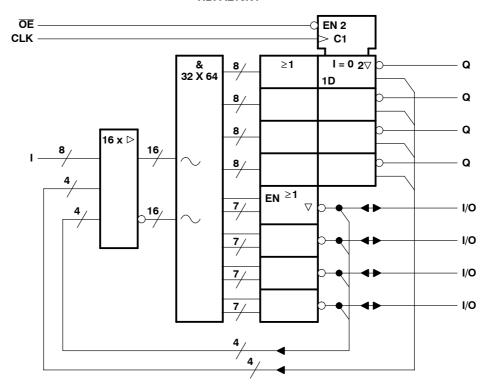


functional block diagrams (positive logic)

TIBPAL16L8



TIBPAL16R4'

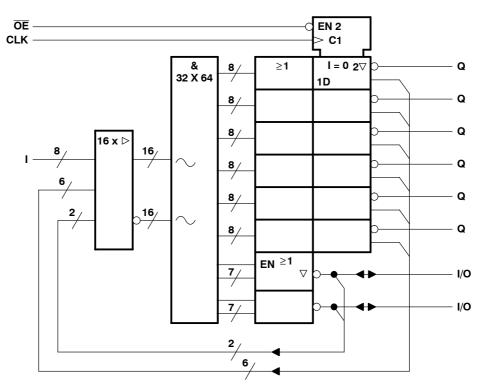


 \sim denotes fused inputs

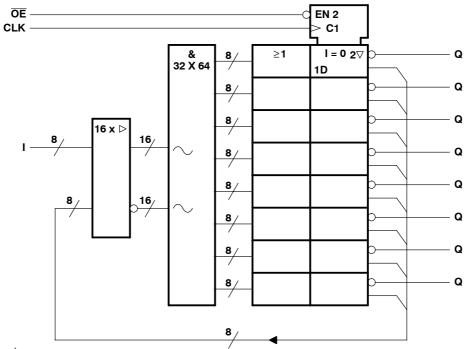
SRPS017A - D3023, MAY 1987 - REVISED DECEMBER 2010

functional block diagrams (positive logic)

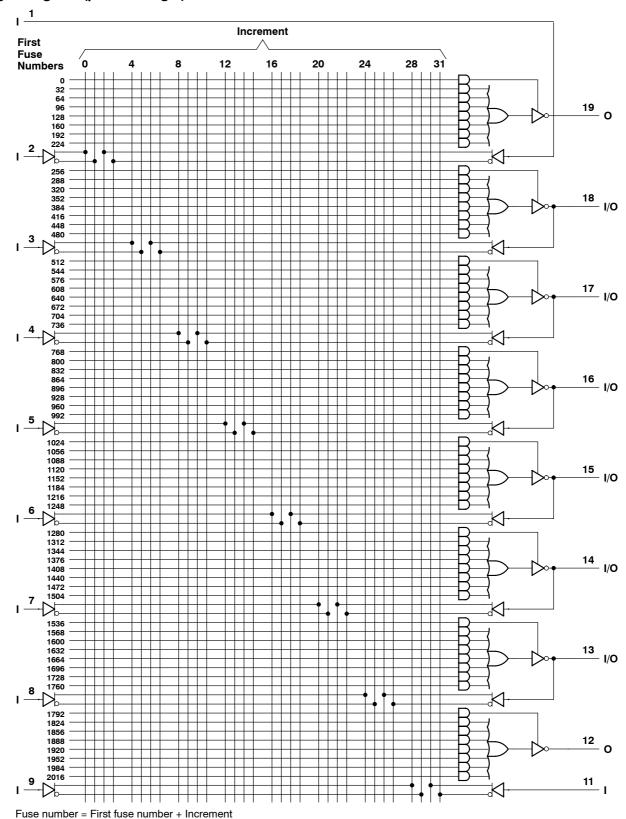
TIBPAL16R6'



TIBPAL16R8'

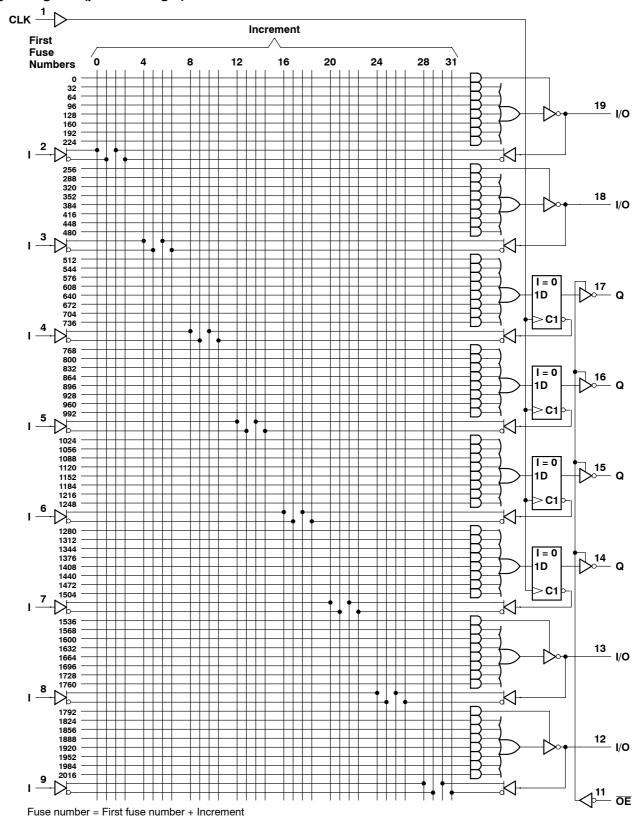


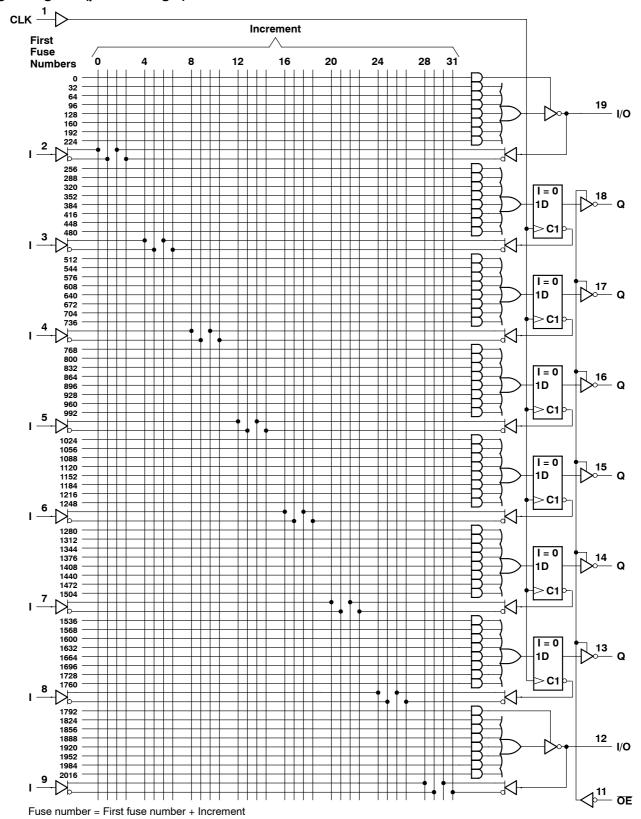
 \sim denotes fused inputs





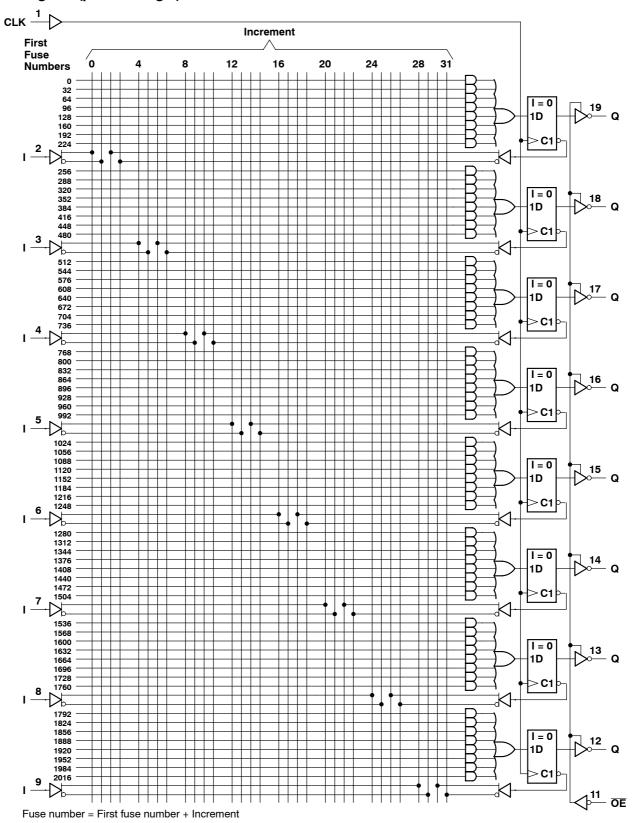
HIGH-PERFORMANCE IMPACT-X TM PAL® CIRCUITS SRPS017A - D3023, MAY 1987 - REVISED DECEMBER 2010





HIGH-PERFORMANCE IMPACT-X ™ PAL® CIRCUITS

SRPS017A - D3023, MAY 1987 - REVISED DECEMBER 2010



TIBPAL16L8-10C, TIBPAL16R4-10C, TIBPAL16R6-10C, TIBPAL16R8-10C HIGH-PERFORMANCE IMPACT-X ™ PAL® CIRCUITS

SRPS017A - D3023, MAY 1987 - REVISED DECEMBER 2010

absolute maximum ratings over operating free-air temperature range (unless otherwise noted)

Supply voltage, V _{CC} (see Note 1)	7 V
Input voltage (see Note 1)	5.5 V
Voltage applied to disabled output (see Note 1)	5.5 V
Operating free-air temperature range	0°C to 75°C
Storage temperature range	-65°C to 150°C

NOTE 1: These ratings apply except for programming pins during a programming cycle.

recommended operating conditions

				MIN	NOM	MAX	UNIT
V_{CC}	Supply voltage			4.75	5	5.25	V
V_{IH}	High-level input voltage (see Note 2)			2		5.5	V
V_{IL}	Low-level input voltage (see Note 2)					0.8	V
I _{OH}	High-level output current					-3.2	mA
I _{OL}	Low-level output current					24	mA
f _{clock}	Clock frequency			0		62.5	MHz
	Dulas duration alsolutas Nata ()	High		8			20
τ _w	Pulse duration, clock (see Note 2)	Low		8			ns
t _{su}	Setup time, input or feedback before clock↑						ns
t _h	Hold time, input or feedback after clock↑			0			ns
T _A	Operating free-air temperature			0	25	75	°C

NOTE 2: These are absolute voltage levels with respect to the ground pin of the device and include all overshoots due to system and/or tester noise. Testing these parameters should not be attempted without suitable equipment.

electrical characteristics over recommended operating free-air temperature range

PARAMETER		TEST CONDITIONS		MIN	TYP [†]	MAX	UNIT
V _{IK}	V _{CC} = 4.75 V,	I _I = –18 mA			-0.8	-1.5	V
V _{OH}	$V_{CC} = 4.75 V$,	$I_{OH} = -3.2 \text{ mA}$		2.4	3.2		V
V _{OL}	$V_{CC} = 4.75 V$,	I _{OL} = 24 mA			0.3	0.5	V
I _{OZH} [‡]	V _{CC} = 5.25 V,	V _O = 2.4 V				100	μΑ
I _{OZL} ‡	V _{CC} = 5.25 V,	$V_0 = 0.4 \text{ V}$				-100	μΑ
I _I	V _{CC} = 5.25 V,	V _I = 5.5 V				0.2	mA
I _{IH} ‡	V _{CC} = 5.25 V,	V _I = 2.4 V				25	μΑ
I _{IL} ‡	V _{CC} = 5.25 V,	$V_{I} = 0.4 \text{ V}$			-0.08	-0.25	mA
I _{OS} §	V _{CC} = 5.25 V,	V _O = 0		-30	-70	-130	mA
I _{CC}	V _{CC} = 5.25 V,	V _I = 0,	Outputs open		140	180	mA
C _i	f = 1 MHz,	V _I = 2 V			5		pF
Co	f = 1 MHz,	V _O = 2 V			6		pF
C _{i/o}	f = 1 MHz,	V _{I/O} = 2 V			7.5		pF
C _{clk}	f = 1 MHz,	V _{CLK} = 2 V			6		pF

 $^{^{\}dagger}$ All typical values are at V_{CC} = 5 V, T_A = 25°C.



 $^{^{\}ddagger}$ I/O leakage is the worst case of I_{OZL} and I_{IL} or I_{OZH} and I_{IH} respectively.

[§] Not more than one output should be shorted at a time, and the duration of the short circuit should not exceed one second.

TIBPAL16L8-10C, TIBPAL16R4-10C, TIBPAL16R6-10C, TIBPAL16R8-10C HIGH-PERFORMANCE $IMPACT-X \stackrel{\text{\tiny TM}}{\longrightarrow} PAL^{\tiny \textcircled{\tiny B}}$ CIRCUITS

SRPS017A - D3023, MAY 1987 - REVISED DECEMBER 2010

switching characteristics over recommended ranges of supply voltage and operating free-air temperature (unless otherwise noted)

PARAMETER	FROM (INPUT)	TO (OUTPUT)	TEST CONDITION	MIN	TYP†	MAX	UNIT
f	\	With feedback		55.5	80		MHz
^T max	W	ithout feedback		62.5	85		1411 12
t _{pd}	I, I/O	O, I/O	R1 = 200 Ω ,	3	7	10	ns
t _{pd}	CLK [↑]	Q	R2 = 390 Ω ,	2	5	8	ns
t _{en}	OE↓	Q	See Figure 3	1	4	10	ns
t _{dis}	OE↑	Q		1	4	10	ns
t _{en}	I, I/O	O, I/O		3	8	10	ns
t _{dis}	I, I/O	O, I/O		3	8	10	ns

 $^{^{\}dagger}$ All typical values are at V_{CC} = 5 V, T_{A} = 25°C.

 $^{^{\}ddagger} f_{\text{max}}(\text{with feedback}) \ = \ \frac{1}{t_{\text{Su}} \ + \ t_{\text{pd}} \ (\text{CLK to Q})}, \ f_{\text{max}}(\text{without feedback}) \ = \ \frac{1}{t_{\text{W}} \ \text{high} \ + \ t_{\text{W}} \ \text{low}}$

TIBPAL16L8-12M, TIBPAL16R4-12M, TIBPAL16R6-12M, TIBPAL16R8-12M HIGH-PERFORMANCE $IMPACT-X \stackrel{\top M}{\longrightarrow} PAL^{\textcircled{\tiny B}}$ CIRCUITS

SRPS017D - D3023, MAY 1987 - REVISED DECEMBER 2010

absolute maximum ratings over operating free-air temperature range (unless otherwise noted)

Supply voltage, V _{CC} (see Note 1)	7 V
Input voltage (see Note 1)	5.5 V
Voltage applied to disabled output (see Note 1)	5.5 V
Operating free-air temperature range	-55°C to 125°C
Storage temperature range	-65°C to 150°C

NOTE 1: These ratings apply except for programming pins during a programming cycle.

recommended operating conditions

			MIN	NOM	MAX	UNIT
V_{CC}	Supply voltage		4.5	5	5.5	V
V_{IH}	High-level input voltage		2		5.5	V
V _{IL}	Low-level input voltage				0.8	V
I _{OH}	High-level output current				-2	mA
I _{OL}	Low-level output current				12	mA
f _{clock} †	Clock frequency		0		56	MHz
	Pulse duration, clock (see Note 2)	High	9			ns
τ _W	Fulse duration, clock (see Note 2)	Low	9			113
t _{su} †	Setup time, input or feedback before clock↑					ns
t _h †	Hold time, input or feedback after clock↑					ns
T _A	Operating free-air temperature				125	°C

NOTE 2: These are absolute voltage levels with respect to the ground pin of the device and include all overshoots due to system and/or tester noise. Testing these parameters should not be attempted without suitable equipment.

electrical characteristics over recommended operating free-air temperature range

PARAMETER		TEST CONDITIONS	3	MIN	TYP†	MAX	UNIT
V _{IK}	$V_{CC} = 4.5 \text{ V},$	I _I = –18 mA			-0.8	-1.5	V
V _{OH}	$V_{CC} = 4.5 \text{ V},$	$I_{OH} = -2 \text{ mA}$		2.4	3.2		V
V_{OL}	$V_{CC} = 4.5 \text{ V},$	I _{OL} = 12 mA			0.3	0.5	٧
I _{OZH} ‡	$V_{CC} = 5.5 V$,	$V_0 = 2.4 \text{ V}$				100	μΑ
I _{OZL} ‡	$V_{CC} = 5.5 \text{ V},$	$V_0 = 0.4 \text{ V}$				-100	μΑ
I _I	V _{CC} = 5.5 V,	V _I = 5.5 V				0.2	mA
I _{IH} ‡	$V_{CC} = 5.5 \text{ V},$	$V_{I} = 2.4 \text{ V}$				25	μΑ
I _{IL} ‡	$V_{CC} = 5.5 \text{ V},$	V _I = 0.4 V			-0.08	-0.25	mA
I _{OS} §	V _{CC} = 5.5 V,	V _O = 0.5 V		-30	-70	-250	mA
I _{CC}	$V_{CC} = 5.5 \text{ V},$	V _I = GND,	Outputs open		140	220	mA
C _i	f = 1 MHz,	V _I = 2 V			5		pF
Co	f = 1 MHz,	V _O = 2 V			6		pF
C _{i/o}	f = 1 MHz,	$V_{I/O} = 2 V$			7.5		pF
C _{clk}	f = 1 MHz,	V _{CLK} = 2 V			6		pF

 $^{^{\}dagger}$ All typical values are at V_{CC} = 5 V, T_A = 25°C.



 $^{^{\}ddagger}$ I/O leakage is the worst case of I_{OZL} and I_{IL} or I_{OZH} and I_{IH} respectively.

[§] Not more than one output should be shorted at a time, and the duration of the short circuit should not exceed one second. V_O is set at 0.5 V to avoid test problems caused by test equipment ground degradation.

TIBPAL16L8-12M, TIBPAL16R4-12M, TIBPAL16R6-12M, TIBPAL16R8-12M HIGH-PERFORMANCE IMPACT-X $^{\text{TM}}$ PAL $^{\text{(B)}}$ CIRCUITS

SRPS017D - D3023, MAY 1987 - REVISED DECEMBER 2010

switching characteristics over recommended ranges of supply voltage and operating free-air temperature (unless otherwise noted)

PARAMETER	FROM (INPUT)	TO (OUTPUT)	TEST CONDITION	MIN	TYP†	MAX	UNIT
With feedback			48	80		MHz	
Tmax	W	ithout feedback	7	56	85		IVII IZ
t _{pd}	I, I/O	O, I/O	R1 = 390 Ω ,	3	7	12	ns
t _{pd}	CLK [↑]	Q	R2 = 750 Ω ,	2	5	10	ns
t _{en}	OE↓	Q	See Figure 3	1	4	10	ns
t _{dis}	OE↑	Q		1	4	10	ns
t _{en}	I, I/O	O, I/O		3	8	14	ns
t _{dis}	I, I/O	O, I/O		2	8	12	ns

 $^{^{\}dagger}$ All typical values are at V_{CC} = 5 V, T_{A} = 25°C.

 $^{^{\}ddagger} f_{\text{max}}(\text{with feedback}) \ = \ \frac{1}{t_{\text{su}} \ + \ t_{\text{pd}} \ (\text{CLK to Q})}, \ f_{\text{max}}(\text{without feedback}) \ = \ \frac{1}{t_{\text{W}} \ \text{high} \ + \ t_{\text{W}} \ \text{low}}$

TIBPAL16L8-10C, TIBPAL16R4-10C, TIBPAL16R6-10C, TIBPAL16R8-10C TIBPAL16L8-12M, TIBPAL16R4-12M, TIBPAL16R6-12M, TIBPAL16R8-12M HIGH-PERFORMANCE IMPACT-X TM PAL® CIRCUITS

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programming information

Texas Instruments programmable logic devices can be programmed using widely available software and inexpensive device programmers.

Complete programming specifications, algorithms, and the latest information on hardware, software, and firmware are available upon request. Information on programmers capable of programming Texas Instruments programmable logic is also available, upon request, from the nearest TI field sales office, local authorized TI distributor, or by calling Texas Instruments at (214) 997-5666.

preload procedure for registered outputs (see Figure 1 and Note 3)

The output registers can be preloaded to any desired state during device testing. This permits any state to be tested without having to step through the entire state-machine sequence. Each register is preloaded individually by following the steps given below.

- Step 1. With V_{CC} at 5 volts and Pin 1 at V_{IL} , raise Pin 11 to V_{IHH} .
- Step 2. Apply either V_{IL} or V_{IH} to the output corresponding to the register to be preloaded.
- Step 3. Pulse Pin 1, clocking in preload data.
- Step 4. Remove output voltage, then lower Pin 11 to $V_{\rm IL}$. Preload can be verified by observing the voltage level at the output pin.

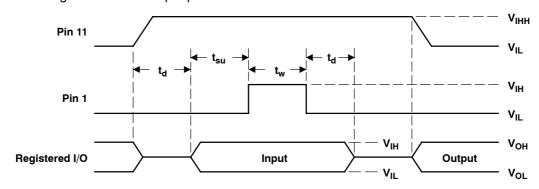


Figure 1. Preload Waveforms

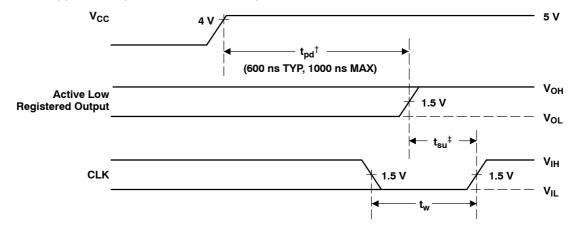
NOTE 3: t_d = t_{su} = t_h = 100 ns to 1000 ns V_{IHH} = 10.25 V to 10.75 v

TIBPAL16L8-10C, TIBPAL16R4-10C, TIBPAL16R6-10C, TIBPAL16R8-10C TIBPAL16L8-12M, TIBPAL16R4-12M, TIBPAL16R6-12M, TIBPAL16R8-12M HIGH-PERFORMANCE $IMPACT-X \ ^{\text{TM}} PAL^{\textcircled{\tiny B}}$ CIRCUITS

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power-up reset (see Figure 2)

Following power up, all registers are reset to zero. This feature provides extra flexibility to the system designer and is especially valuable in simplifying state-machine initialization. To ensure a valid power-up reset, it is important that the rise of V_{CC} be monotonic. Following power-up reset, a low-to-high clock transition must not occur until all applicable input and feedback setup times are met.



[†] This is the power-up reset time and applies to registered outputs only. The values shown are from characterization data.

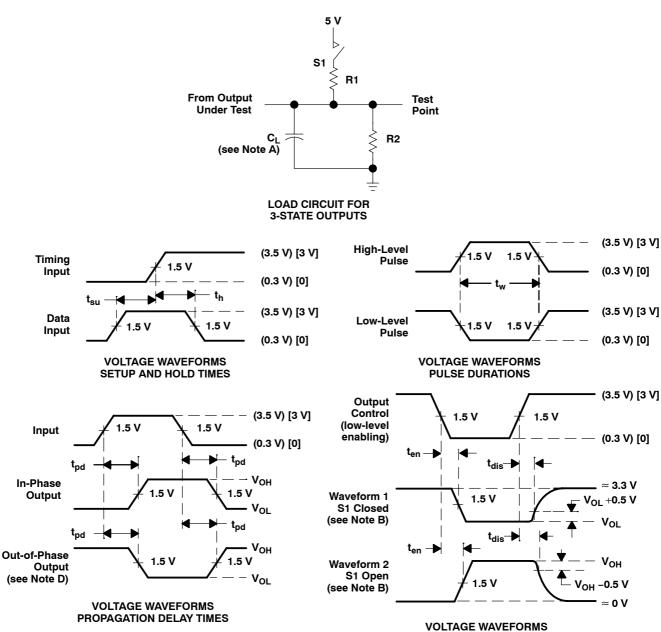
Figure 2. Power-Up Reset Waveforms



[‡] This is the setup time for input or feedback.

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PARAMETER MEASUREMENT INFORMATION



NOTES: A. C_L includes probe and jig capacitance and is 50 pF for t_{pd} and t_{en}, 5 pF for t_{dis}.

B. Waveform 1 is for an output with internal conditions such that the output is low except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high except when disabled by the output control.

ENABLE AND DISABLE TIMES, 3-STATE OUTPUTS

- C. All input pulses have the following characteristics: For C suffix, use the voltage levels indicated in parentheses (), PRR \leq 1 MHz, $t_r = t_f = 2$ ns, duty cycle = 50%; For M suffix, use the voltage levels indicated in brackets [], PRR \leq 10 MHz, t_r and $t_f \leq$ 2 ns, duty cycle = 50%
- D. When measuring propagation delay times of 3-state outputs, switch S1 is closed.
- E. Equivalent loads may be used for testing.

Figure 3. Load Circuit and Voltage Waveforms



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metastable characteristics of TIBPAL16R4-10C, TIBPAL16R6-10C, and TIBPAL16R8-10C

At some point a system designer is faced with the problem of synchronizing two digital signals operating at two different frequencies. This problem is typically overcome by synchronizing one of the signals to the local clock through use of a flip-flop. However, this solution presents an awkward dilemma since the setup and hold time specifications associated with the flip-flop are sure to be violated. The metastable characteristics of the flip-flop can influence overall system reliability.

Whenever the setup and hold times of a flip-flop are violated, its output response becomes uncertain and is said to be in the metastable state if the output hangs up in the region between V_{IL} and V_{IH} . This metastable condition lasts until the flip-flop falls into one of its two stable states, which takes longer than the specified maximum propagation delay time (CLK to Q max).

From a system engineering standpoint, a designer cannot use the specified data sheet maximum for propagation delay time when using the flip-flop as a data synchronizer – how long to wait after the specified data sheet maximum must be known before using the data in order to guarantee reliable system operation.

The circuit shown in Figure 4 can be used to evaluate MTBF (Mean Time Between Failure) and Δt for a selected flip-flop. Whenever the Q output of the DUT is between 0.8 V and 2 V, the comparators are in opposite states. When the Q output of the DUT is higher than 2 V or lower than 0.8 V, the comparators are at the same logic level. The outputs of the two comparators are sampled a selected time (Δt) after SCLK. The exclusive OR gate detects the occurrence of a failure and increments the failure counter.

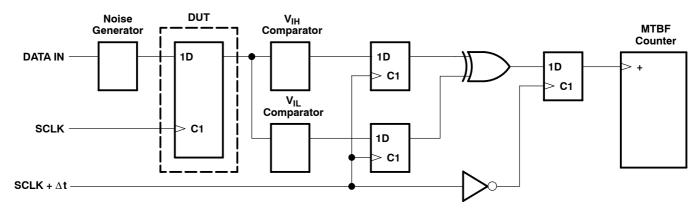


Figure 4. Metastable Evaluation Test Circuit

In order to maximize the possibility of forcing the DUT into a metastable state, the input data signal is applied so that it always violates the setup and hold time. This condition is illustrated in the timing diagram in Figure 5. Any other relationship of SCLK to data will provide less chance for the device to enter into the metastable state.

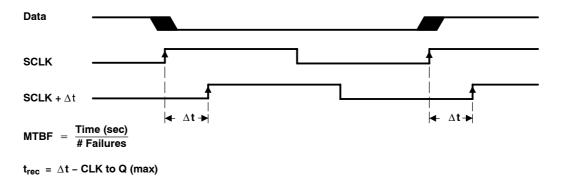


Figure 5. Timing Diagram



By using the described test circuit, MTBF can be determined for several different values of Δt (see Figure 4). Plotting this information on semilog scale demonstrates the metastable characteristics of the selected flip-flop. Figure 6 shows the results for the TIBPAL16'-10C operating at 1 MHz.

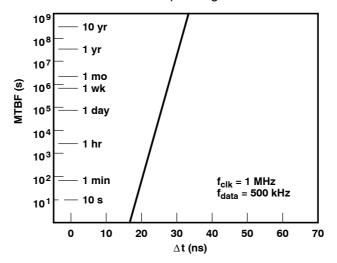


Figure 6. Metastable Characteristics

From the data taken in the above experiment, an equation can be derived for the metastable characteristics at other clock frequencies.

The metastable equation:
$$\frac{1}{MTBF} = f_{SCLK} \times f_{data} \times C1 e (-C2 \times \Delta t)$$

The constants C1 and C2 describe the metastable characteristics of the device. From the experimental data, these constants can be solved for: $C1 = 9.15 \times 10^{-7}$ and C2 = 0.959

Therefore

$$\frac{1}{\text{MTBF}}$$
 = $f_{\text{SCLK}} \times f_{\text{data}} \times 9.15 \times 10^{-7} \text{ e} (-0.959 \times \Delta t)$

definition of variables

DUT (Device Under Test): The DUT is a 10-ns registered PLD programmed with the equation Q : = D.

MTBF (Mean Time Between Failures): The average time (s) between metastable occurrences that cause a violation of the device specifications.

f_{SCLK} (system clock frequency): Actual clock frequency for the DUT.

f_{data} (data frequency): Actual data frequency for a specified input to the DUT.

C1: Calculated constant that defines the magnitude of the curve.

C2: Calculated constant that defines the slope of the curve.

 t_{rec} (metastability recovery time): Minimum time required to guarantee recovery from metastability, at a given MTBF failure rate. $t_{rec} = \Delta t - t_{rec}$ (CLK to Q, max)

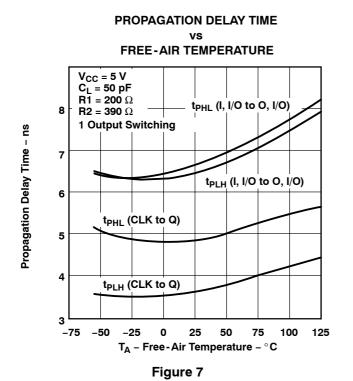
Δt: The time difference (ns) from when the synchronizing flip-flop is clocked to when its output is sampled.

The test described above has shown the metastable characteristics of the TIBPAL16R4/R6/R8-10C series. For additional information on metastable characteristics of Texas Instruments logic circuits, please refer to TI Applications publication SDAA004, "Metastable Characteristics, Design Considerations for ALS, AS, and LS Circuits."



SRPS017A - D3023, MAY 1987 - REVISED DECEMBER 2010

TYPICAL CHARACTERISTICS



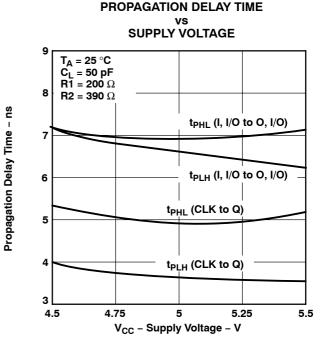


Figure 8

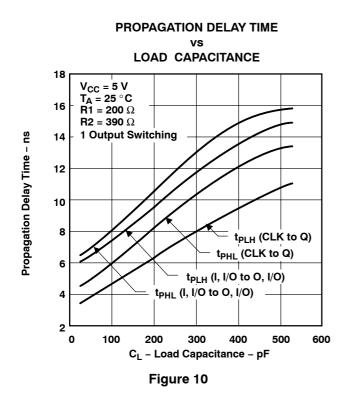
PROPAGATION DELAY TIME

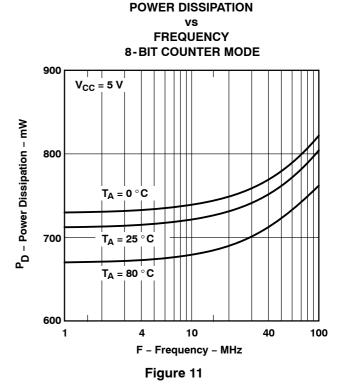
NUMBER OF OUTPUTS SWITCHING V_{CC} = 5 V T_A = 25 °C 10 $C_L = 50 pF$ $R\bar{1} = 200 \Omega$ $R2 = 390 \Omega$ Propagation Delay Time - ns t_{PHL} (I, I/O to O, I/O) 8 7 t_{PLH} (I, I/O to O, I/O) 6 5 t_{PHL} (CLK to Q) t_{PLH} (CLK to Q) 3 0 2 8 3 5 7 **Number of Outputs Switching**

Figure 9

SRPS017A - D3023, MAY 1987 - REVISED DECEMBER 2010

TYPICAL CHARACTERISTICS





SUPPLY CURRENT FREE-AIR TEMPERATURE 180 **Unprogrammed Device** 170 V_{CC} = 5.5 V I_{CC} - Supply Current - mA 160 $V_{CC} = 5.25 V$ 150 140 130 V_{CC} = 5 V 120 $V_{CC} = 4.75 V$ 110 V_{CC} = 4.5 V 100 -75 -50 -25 25 T_A - Free-Air Temperature - °C



Figure 12

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5962-85155132A	ACTIVE	LCCC	FK	20	1	TBD	POST-PLATE	N / A for Pkg Type	
5962-8515513RA	ACTIVE	CDIP	J	20	1	TBD	A42	N / A for Pkg Type	
5962-8515513SA	ACTIVE	CFP	W	20	1	TBD	Call TI	N / A for Pkg Type	
5962-85155142A	OBSOLETE	LCCC	FK	20		TBD	Call TI	Call TI	
5962-8515514RA	OBSOLETE	CDIP	J	20		TBD	Call TI	Call TI	
5962-8515514SA	OBSOLETE	CFP	W	20		TBD	Call TI	Call TI	
5962-85155152A	ACTIVE	LCCC	FK	20	1	TBD	POST-PLATE	N / A for Pkg Type	
5962-8515515RA	ACTIVE	CDIP	J	20	1	TBD	A42	N / A for Pkg Type	
5962-8515515SA	ACTIVE	CFP	W	20	1	TBD	Call TI	N / A for Pkg Type	
5962-85155162A	ACTIVE	LCCC	FK	20	1	TBD	POST-PLATE	N / A for Pkg Type	
5962-8515516RA	ACTIVE	CDIP	J	20	1	TBD	A42	N / A for Pkg Type	
5962-8515516SA	ACTIVE	CFP	W	20	1	TBD	Call TI	N / A for Pkg Type	
TIBPAL16L8-10CFN	ACTIVE	PLCC	FN	20	46	TBD	CU SNPB	Level-1-220C-UNLIM	
TIBPAL16L8-10CN	ACTIVE	PDIP	N	20	20	Pb-Free (RoHS)	CU NIPDAU	N / A for Pkg Type	
TIBPAL16L8-12MFKB	ACTIVE	LCCC	FK	20	1	TBD	POST-PLATE	N / A for Pkg Type	
TIBPAL16L8-12MJ	ACTIVE	CDIP	J	20	1	TBD	A42	N / A for Pkg Type	
TIBPAL16L8-12MJB	ACTIVE	CDIP	J	20	1	TBD	A42	N / A for Pkg Type	
TIBPAL16L8-12MWB	ACTIVE	CFP	W	20	1	TBD	Call TI	N / A for Pkg Type	
TIBPAL16R4-10CFN	ACTIVE	PLCC	FN	20	46	TBD	CU SNPB	Level-1-220C-UNLIM	
TIBPAL16R4-10CN	ACTIVE	PDIP	N	20	20	Pb-Free (RoHS)	CU NIPDAU	N / A for Pkg Type	
TIBPAL16R4-12MFKB	ACTIVE	LCCC	FK	20	1	TBD	POST-PLATE	N / A for Pkg Type	
TIBPAL16R4-12MJ	ACTIVE	CDIP	J	20	1	TBD	A42	N / A for Pkg Type	
TIBPAL16R4-12MJB	ACTIVE	CDIP	J	20	1	TBD	A42	N / A for Pkg Type	
TIBPAL16R4-12MWB	ACTIVE	CFP	W	20	1	TBD	Call TI	N / A for Pkg Type	
TIBPAL16R6-10CFN	ACTIVE	PLCC	FN	20	46	TBD	CU SNPB	Level-1-220C-UNLIM	
TIBPAL16R6-10CN	ACTIVE	PDIP	N	20	20	Pb-Free (RoHS)	CU NIPDAU	N / A for Pkg Type	
TIBPAL16R6-12MFKB	ACTIVE	LCCC	FK	20	1	TBD	POST-PLATE	N / A for Pkg Type	
TIBPAL16R6-12MJB	ACTIVE	CDIP	J	20	1	TBD	A42	N / A for Pkg Type	
TIBPAL16R6-12MWB	ACTIVE	CFP	W	20	1	TBD	Call TI	N / A for Pkg Type	
TIBPAL16R8-10CFN	OBSOLETE		FN	20	DTI	TBD CONT	Call TI	Call TI	





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Orderable Device	Status ⁽¹⁾	Package Type	Package Drawing	Pins	Package Qty	Eco Plan ⁽²⁾	Lead/ Ball Finish	MSL Peak Temp ⁽³⁾	Samples (Requires Login)
TIBPAL16R8-10CN	OBSOLETE	PDIP	N	20		TBD	Call TI	Call TI	
TIBPAL16R8-12MFKB	OBSOLETE	LCCC	FK	20		TBD	Call TI	Call TI	
TIBPAL16R8-12MJ	LIFEBUY	CDIP	J	20		TBD	Call TI	Call TI	
TIBPAL16R8-12MJB	OBSOLETE	CDIP	J	20		TBD	Call TI	Call TI	
TIBPAL16R8-12MWB	OBSOLETE	CFP	W	20		TBD	Call TI	Call TI	

(1) The marketing status values are defined as follows:

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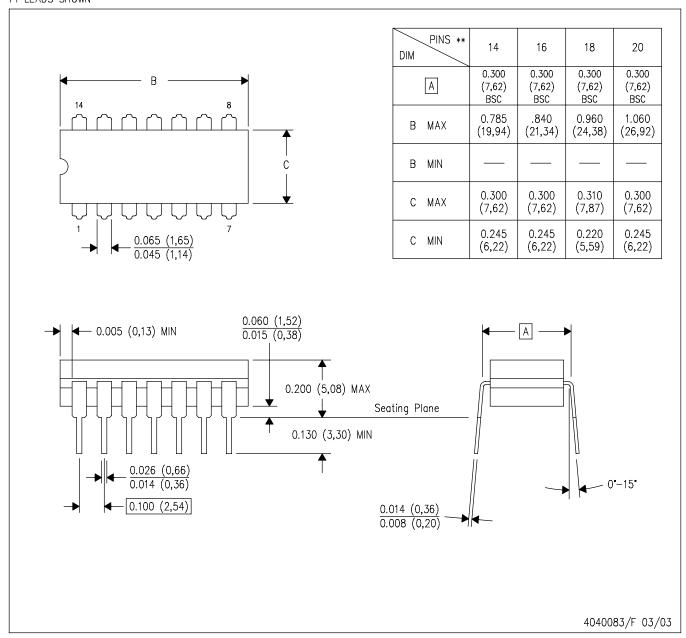
Green (RoHS & no Sb/Br): TI defines "Green" to mean Pb-Free (RoHS compatible), and free of Bromine (Br) and Antimony (Sb) based flame retardants (Br or Sb do not exceed 0.1% by weight in homogeneous material)

(3) MSL, Peak Temp. -- The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

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14 LEADS SHOWN



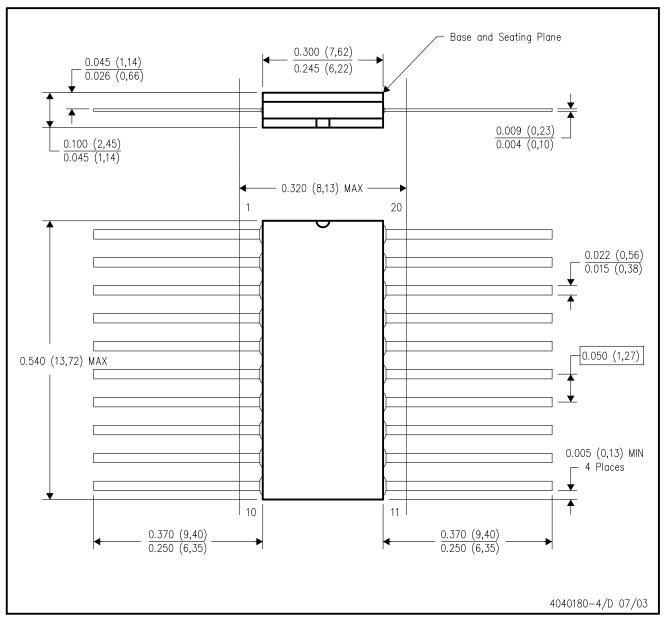
NOTES:

- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- C. This package is hermetically sealed with a ceramic lid using glass frit.
- D. Index point is provided on cap for terminal identification only on press ceramic glass frit seal only.
- E. Falls within MIL STD 1835 GDIP1-T14, GDIP1-T16, GDIP1-T18 and GDIP1-T20.

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W (R-GDFP-F20)

CERAMIC DUAL FLATPACK



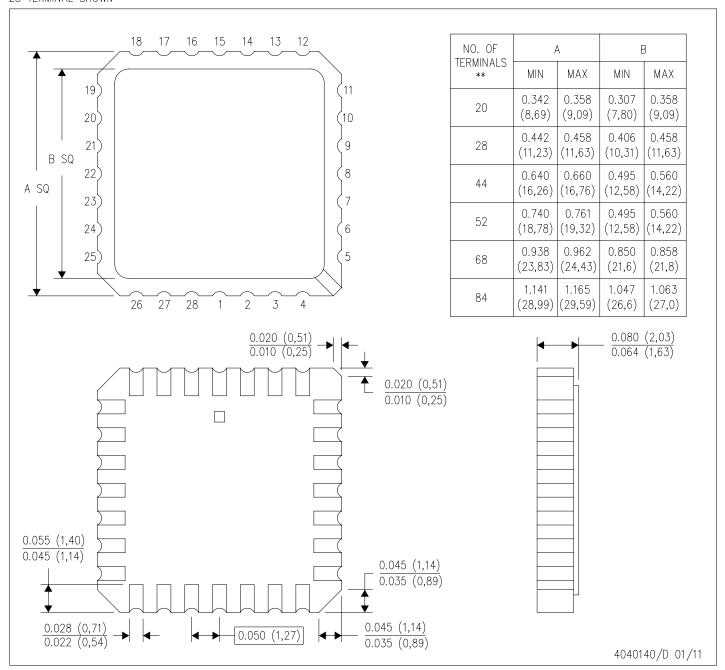
NOTES:

- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- C. This package can be hermetically sealed with a ceramic lid using glass frit.
- D. Index point is provided on cap for terminal identification only.
- E. Falls within Mil-Std 1835 GDFP2-F20

FK (S-CQCC-N**)

LEADLESS CERAMIC CHIP CARRIER

28 TERMINAL SHOWN



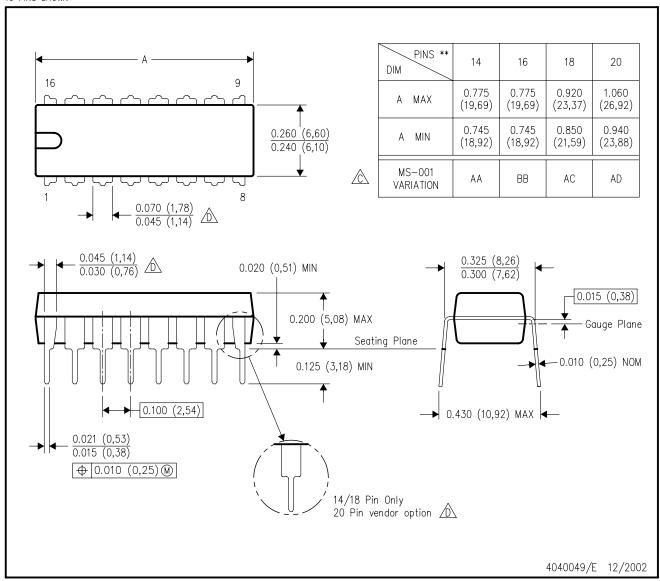
NOTES:

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- B. This drawing is subject to change without notice.
- C. This package can be hermetically sealed with a metal lid.
- D. Falls within JEDEC MS-004

N (R-PDIP-T**)

PLASTIC DUAL-IN-LINE PACKAGE

16 PINS SHOWN



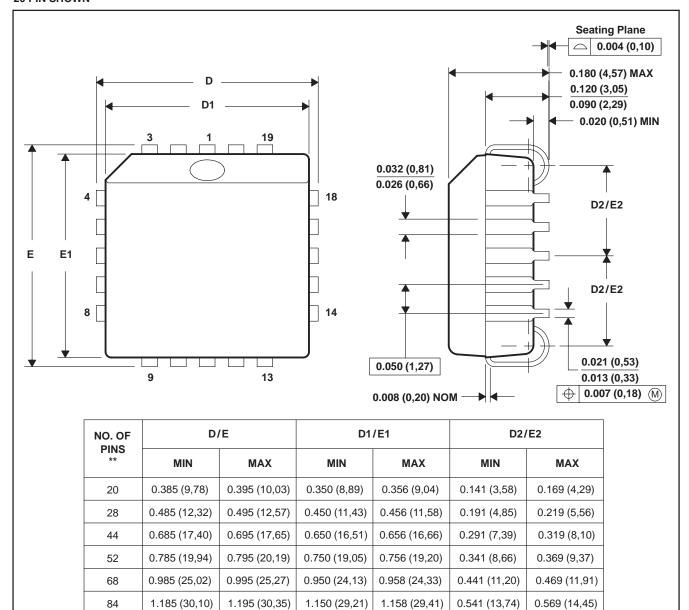
NOTES:

- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- Falls within JEDEC MS-001, except 18 and 20 pin minimum body length (Dim A).
- The 20 pin end lead shoulder width is a vendor option, either half or full width.

FN (S-PQCC-J**)

20 PIN SHOWN

PLASTIC J-LEADED CHIP CARRIER



NOTES: A. All linear dimensions are in inches (millimeters).

- B. This drawing is subject to change without notice.
- C. Falls within JEDEC MS-018

4040005/B 03/95

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